

BT8926B2

Audio Player Microcontroller

Versions: 0.0.1 2021.06.24



Declaration

Copyright © 2021, www. bluetrum.com.

All Rights Reserved. No Unauthorized Distribution.

Bluetrum reserves the right to make changes without further notice to any products herein to improve reliability, function or design.

For further information on the technology, product and business term, please contact Bluetrum Company.

For sales or technical support, please send email to the address:

Sales: sales@bluetrum.com

Technical: project@bluetrum.com



Revision History

Date	Version	Comments	Revised by
2021-06-24	0.0.1	First draft	Leo



Table of Contents

TAE	BLE OF CONTENTS	2
1	PRODUCT FEATURES	
1	TRODUCT LATURES	
2	PACKAGE DEFINITION	4
2.1	Pin Assignment	4
2.2	Pin Descriptions	5
3	CHARACTERISTICS	7
3.1	PMU PARAMETERS	7
3.2	IO Parameters	7
3.3	Audio DAC Parameters	8
3.4	Audio ADC Parameters	
3.5	BT PARAMETERS	
3.6	Current Parameters	9
4	PACKAGE INFORMATION	. 10



1 Product Features

CPU and Flexible IO

- 32bit High performance CPU with DSP instruction
- Program memory: internal 8M bit flash
- Flexible GPIO pins with Programmable pullup and pull-down resistors;
- Support GPIO wakeup or interrupt;

Bluetooth Radio

- Compliant to Bluetooth 5.2 and BLE specification (QDID: 166851);
- TX output power MAX +9dBm;
- RX Sensitivity with -94dBm @2M EDR;
- Support TWS communication with balanceefficiency Power consumption;
- Support TWS Master-slave switch;

Audio Interface

- High performance mono DAC with 98dB SNR, support single end mode or differential mode;
- One channel high performance ADC with 90dB SNR;
- One channel MIC amplifier input;
- Support flexible audio EQ adjust;
- Support Sample rate 8, 11.025, 12, 16, 22.05, 32, 44.1 and 48KHz;
- Four channel Stereo Analog MUX;

Peripheral and Interfaces

- Support AAC, mSBC high quality decode;
- Support Low power Touch Key;
- Support Low power enter ear detect;
- Three 32-bit timers;
- Three multi-function 32-bit timers, support Capture and PWM mode;
- WatchDog;
- Three full-duplex UART;
- Two SPI:
- IR controller;
- Full speed USB 2.0 HOST/DEVICE controller;
- Sixteen Channels 10-bit SARADC:
- Integrate IRTC;
- Build in PMU, such as charger/buck/LDO;

Package

QFN20 3.00x3.00x0.75 e=0.40

Temperature

- Operating temperature: -40° C to $+85^{\circ}$ C;
- Storage temperature: -65° C to $+150^{\circ}$ C;

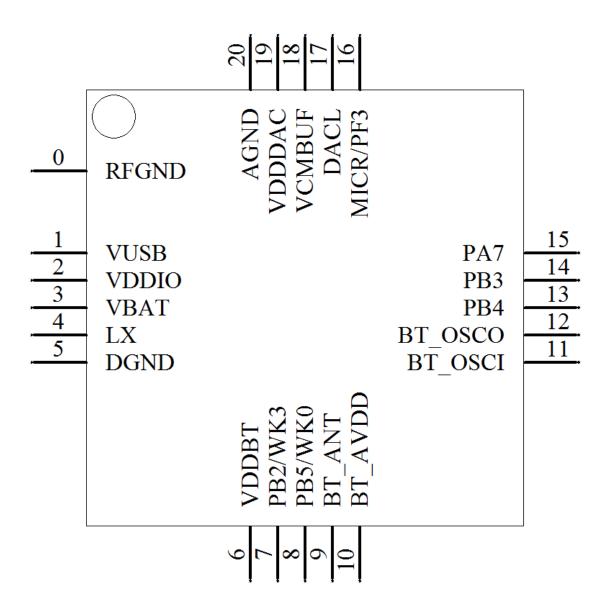
Supports

RF.5.2/ BB.5.2/ LL.5.2/ LMP.5.2/ RFPHY.5.2/ SDP.5.2/ L2CAP.5.2/ A2DP.1.2/ AVCTP.1.4.1/ AVDTP.1.3.4/ AVRCP.1.6.2/ GAVDP.1.3.1/ HFP.1.8/ HID.1.0.14/ IOPT.4.0.1/ RFCOMM.1.2.2/ SPP.1.2.2



2 Package Definition

2.1 Pin Assignment





2.2 Pin Descriptions

Table 2-1 QFN20 pin description

Pin No.	Name	Туре	Function
0	RFGND	GND	RF Ground
1	VUSB	PWR	VUSB power input TX0-G8 TX1-G3 TX2-G3
			HSTRX-G11
2	VDDIO	PWR	VDDIO power output
3	VBAT	PWR	VBAT power input
4	LX	PWR	Buck inductor connect pin
5	DGND	GND	Digital Ground
6	VDDBT	PWR	BT power
7	PB2/WK3		ADC4 AUXR1 SDDAT0-G2 SPI1DO-G3 TX0-G2 TX2-G2 HSTRX-G2 PWM2-T3-G1 IISSCLK-G3 IISDI-G2 IIC_DAT-G3 WK3 PB2
8	PB5/WKO	I/O	ADC12 PWM2-T3-G2 IISDI-G3 WKO PB5
9	BT_ANT	А	BT ANT
10	BT_AVDD	PWR	BT RF Power
11	BT_OSCI	A	24M OSC input
13	BT_OSCO PB4	I/O	24M OSC output ADC6 PDM_DATLR-G4 SDDAT0-G4 SDDAT0-G6 SPI0CLK-G3 RX0-G3 HSTRX-G8 PWM1-T3-G2 IIC_DAT-G8 PB4
14	PB3	I/O	ADC5 PDM_CLKLR-G4 SDDAT0-G5



			SPI0DO-G3
			TX0-G3
			HSTRX-G3
			PWM0-T3-G2
			IIC_CLK-G8
			PB3
			ADC2
			AUXR0
			PDM_DATLR-G3
			SDDAT0-G1/G7
			SPI1DO-G2
15	PA7	I/O	TX0-G1
			TX1-G1
			HSTRX-G1
			PWM2-T5-G1
			IIS_DO-G1
			PA7
			MICPR
16	PF3/MICPR	I/O	PWM2-T4-G2
			PF3
17	DACL	А	DAC L
18	VCMBUF	PWR	VCM buffer output
19	VDDDAC	PWR	DAC power
20	AGND	GND	DAC Ground

Note: I/O: Digital input/output; I: Digital input; A: Analog Pin; PWR: Power Pin; GND: Ground.



3 Characteristics

3.1 PMU Parameters

Table 3-1 PMU voltage input Parameters

Sym	Characteristics	Min	Тур	Max	Unit	Conditions
VUSB	Charger Voltage input	4.6	5.0	5.5	V	
VBAT	Voltage input	3.0	3.7	4.5	V	

Table 3-2 3.3V LDO Parameters

Sym	Characteristics	Min	Тур	Max	Unit	Conditions
VDDIO	3.3V LDO voltage output	-	3.3	-	V	Light Loading condition
△VVDDIO	Output Mismatch 1-sigma	-	43	-	mV	VDDIO=3.3v
ILOAD	Maximum output current	-	-	150	mA	@VBAT=3.6v
ISC	Short Circuit Current Limit	-	-	300	mA	@VBAT=3.8v

Table 3-3 1.2V LDO Parameters

Sym	Characteristics	Min	Тур	Max	Unit	Conditions
VDDBT	1.2V LDO voltage output	-	1.2	-	V	Light Loading condition
\triangle VVDDBT	Output Mismatch 1-sigma	-	16	-	mV	VDDBT=1.2v
ILOAD	Maximum output current	-	-	100	mA	@VBAT=3.0v
ISC	Short Circuit Current Limit	-	-	200	mA	@VBAT=3.8v

Table 3-4 1.1V LDO Parameters

Sym	Characteristics	Min	Тур	Max	Unit	Conditions
VDDCORE	1.1V LDO voltage output	-	1.1	-	V	Light Loading condition
△VVDDCORE	Output Mismatch 1-sigma	-	15	-	mV	VDDCORE=1.1v
ILOAD	Maximum output current	-	-	60	mA	@VBAT=3.6v
ISC	Short Circuit Current Limit	-	-	120	mA	@VBAT=3.8v

3.2 IO Parameters

Table 3-5 I/O Parameters

GPIO—Electrical Characteristics												
Symbol	Description	Related GPIO	Min	Typical	Max	Units	Conditions					
VIL	Low-level input voltage		-0.3		1.27	V	VDDIO=3.3V					
ViH	High-level input voltage		2.03		3.6	V	VDDIO=3.3V					
Driver Ability 1	Output Driver Ability 1			32		mA	VDDIO=3.3V					
Driver Ability 0	Output Driver Ability 0			8		mA	VDDIO=3.3V					
R _{PUP0}	Internal pull-up resister 0		8	10	12	ΚΩ						
R _{PUP1}	Internal pull-up resister 1		0.24	0.3	0.36	ΚΩ						
R _{PUP2}	Internal pull-up resister 2		160	200	240	ΚΩ						
R _{PDN0}	Internal pull-down resister 0		8	10	12	ΚΩ						
R _{PDN1}	Internal pull-down resister 1		0.24	0.3	0.36	ΚΩ						



GPIO—Electrica	I Characteristics					
R _{PDN2}	Internal pull-down resister 2	160	200	240	ΚΩ	

3.3 Audio DAC Parameters

Table 3-6 Audio DAC Parameters

Mode	Sym	Characteristics	Min	Тур	Max	Unit	Conditions
Mode	Sym	Characteristics	WIIN	тур	IVIAX	Unit	
	SNR		-	98.8	-	dB	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -4.2dBV with 10K loading Fin=1KHz
Differential Mode	THD+N		-	-73	-	dB	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -4.2dBV with 10K loading Fin=1KHz
	Output Range	Maximum output voltage	-	-4.2		dBVrms	32ohm Loading
	SNR			96		dB	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -1.1dBV with 10K loading Fin=1KHz
VCMBUF Mode	THD+N			-73		dB	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -1.1dBV with 10K loading Fin=1KHz
	Output Range	Maximum output voltage		-1.1		dBVrms	32ohm Loading
	SNR			95		dB	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -1.1dBV with 10K loading@220uF AC coupling Cap Fin=1KHz
AC Coupling Mode	THD+N	Maximum output voltage		-73 -1.1		dB dBVrms	VCM cap=NC VDDDAC cap=1uF with A-wt filter Output -1.1dBV with 10K loading@220uF AC coupling Cap Fin=1KHz 320hm Loading

3.4 Audio ADC Parameters

Table 3-7 Audio ADC Parameters



Sym	Characteristics	Min	Тур	Max	Unit	Conditions	
				-		VCM cap=NC VDDDAC cap=1uF	
SNR		-	90		dB	with A-wt filter	
						Input sine amplitude, 850mV RMS Fin=1KHz	
		-	-	-		VCM cap=NC	
						VDDDAC cap=1uF	
THD+N					dB	with A-wt filter Input sine amplitude, 850mV RMS	
						Fin=1KHz.	
Input Range	Input sine wave peak amplitude	\/CM-1 2\/	_	VCM+1.2	V	From aux input, aux 0db gain,	
par.rango	par aa mara paan ampinada	. J 1.2 v			•	VCM represent VCM voltage.	

3.5 BT Parameters

Table 3-8 BT Parameters

Characteristics	Min	Typical	Max	Unit	Conditions
Maximum Transmit Power	-	-	9	dBm	
RMS DEVM	-	5.5	-	%	Manipular TV a suns
Peak DEVM	-	12.5		%	Maximum TX power
EDR Relative Transmit Power		-0.2		dB	2-DH5 packet
Sensitivity @ Basic Rate		-91.8		dBm	BER=0.1%, using DH5 packet
Sensitivity @ EDR		-94		dBm	BER=0.01%, using 2-DH5 packet

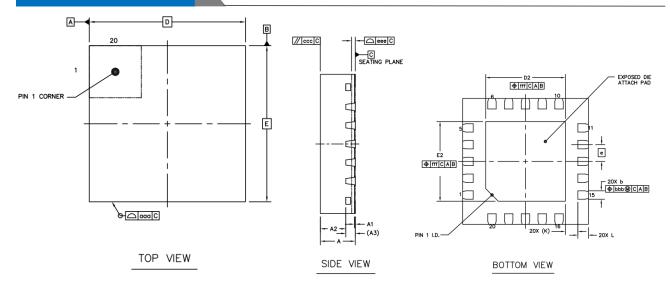
3.6 Current Parameters

Table 3-9 Current Parameters

S	sym	Characteristics	Min	Тур	Max	Unit	Conditions
IF	RTC	RTC mode current	-	4	-	uA	4.2V input, room temp.
S	leep	Sleep current	-	500	2000	uA	3.3V input, room temp



Package Information



		SYMBOL	MIN	NOM	MAX		
TOTAL THICKNESS		Α	0.7	0.75	0.8		
STAND OFF		A1	0	0.02	0.05		
MOLD THICKNESS		A2		0.55			
L/F THICKNESS		A3	0.203 REF				
LEAD WIDTH		b	0.15 0.2		0.25		
BODY SIZE	×	D	3 BSC				
	Y	E	3 BSC				
LEAD PITCH	е	0.4 BSC					
EP SIZE	X	D2	1.8	1.9	2		
EP SIZE	Y	E2	1.8	1.9	2		
LEAD LENGTH	L	0.15	0.25	0.35			
LEAD TIP TO EXPOSED PAD EDGE		K	0.3 REF				
PACKAGE EDGE TOLERANCE		aaa	0.1				
MOLD FLATNESS	ccc	0.1					
COPLANARITY	eee	0.08					
LEAD OFFSET	bbb	0.07					
EXPOSED PAD OFFSET		fff	0.1				
		1					



